

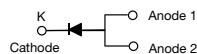
Ultrafast Avalanche Surface Mount Rectifiers

AU3PK, AU3PM

Vishaymas General Semiconductor



TO-277A (SMPC)



PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	3.0 A
V_{RRM}	800 V, 1000 V
I_{FSM}	45 A
t_{rr}	75 ns
E_{AS}	20 mJ
V_F at $I_F = 3.0$ A	1.45 V
T_J max.	175 °C
Package	TO-277A (SMPC)
Diode variations	Single die

TYPICAL APPLICATIONS

For use in lighting, fast switching rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

FEATURES

- Very low profile - typical height of 1.1 mm
- Ideal for automated placement
- Glass passivated pellet chip junction
- Fast reverse recovery time
- Controlled avalanche characteristics
- Low leakage current
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishaymas.com

MECHANICAL DATA

Case: TO-277A (SMPC)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant and AEC-Q101 qualified

Base P/NHM3_X - halogen-free, RoHS-compliant and AEC-Q101 qualified
("X" denotes revision code e.g. A, B,.....)

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	AU3PK	AU3PM	UNIT
Device marking code		AU3K	AU3M	
Maximum repetitive peak reverse voltage	V _{RRM}	800	1000	V
Maximum DC forward current (fig. 1)	I _F ⁽¹⁾	3.0		A
	I _F ⁽²⁾	1.4		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	45		A
Non-repetitive avalanche energy at T _J = 25 °C I_{AS} = 2.5 A max. I_{AS} = 1.0 A typ.	E _{AS}	20		mJ
		30		
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175		°C

Notes

(1) Mounted on 20 mm x 20 mm pad areas, 1 oz. FR4 PCB

(2) Free air, mounted on recommended pad area

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 3.0 A	T _A = 25 °C	V _F ⁽¹⁾	2.27	2.5	V
		T _A = 125 °C		1.45	2.0	
Reverse current	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	0.40	10	μA
		T _A = 125 °C		107	500	
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	58	75	ns
Typical junction capacitance per diode	Rated V _R = 4.0 V, 1 MHz		C _J	42	-	pF

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
(2) Pulse test: Pulse width $\leq 40\text{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)				
PARAMETER	SYMBOL	AU3PK	AU3PM	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)}$	85		$^{\circ}\text{C/W}$
	$R_{\theta JM}^{(2)}$	5		

Notes

- (1) Free air, mounted on recommended PCB 1 oz. pad are; thermal resistance $R_{\theta JA}$ - junction to ambient
(2) Units mounted on PCB with 20 mm x 20 mm copper pad areas; $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
AU3PM-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel
AU3PM-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel
AU3PMHM3/86A ⁽¹⁾	0.10	86A	1500	7" diameter plastic tape and reel
AU3PMHM3/86A ⁽¹⁾	0.10	87A	6500	13" diameter plastic tape and reel
AU3PMHM3_A/H ⁽¹⁾	0.10	H	1500	7" diameter plastic tape and reel
AU3PMHM3_A/I ⁽¹⁾	0.10	I	6500	13" diameter plastic tape and reel

Note

- (1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25^\circ\text{C}$ unless otherwise noted)

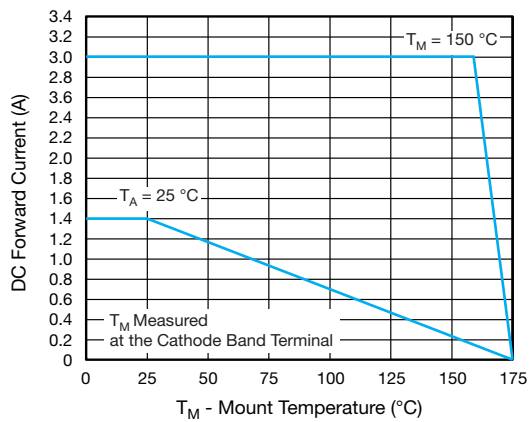


Fig. 1 - Maximum Forward Current Derating Curve

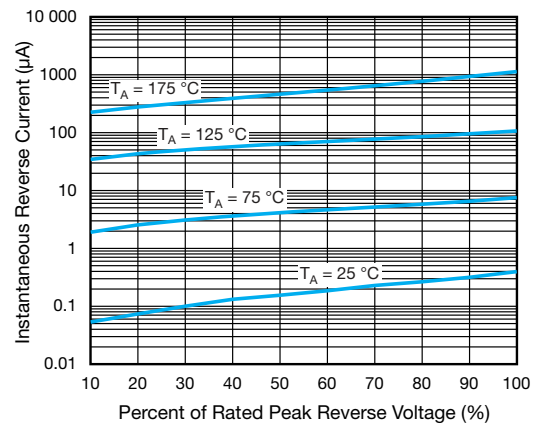


Fig. 4 - Typical Reverse Leakage Characteristics

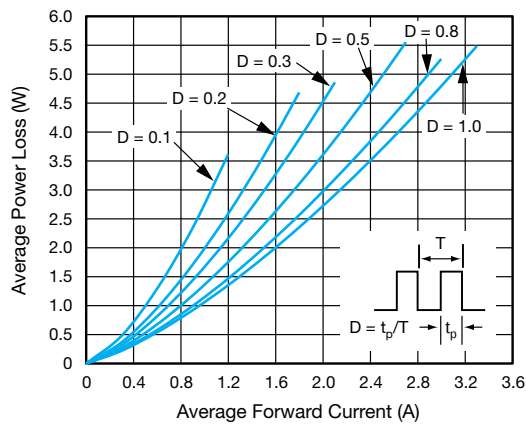


Fig. 2 - Average Power Loss Characteristics

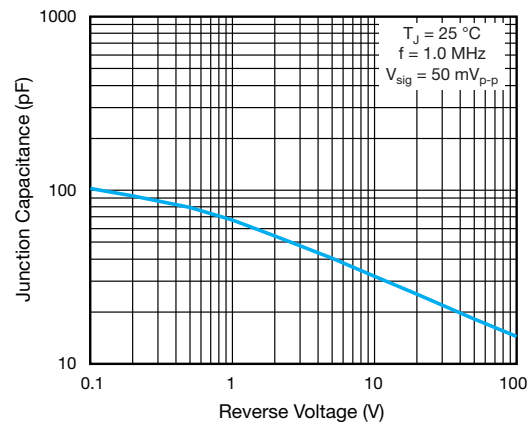


Fig. 5 - Typical Junction Capacitance

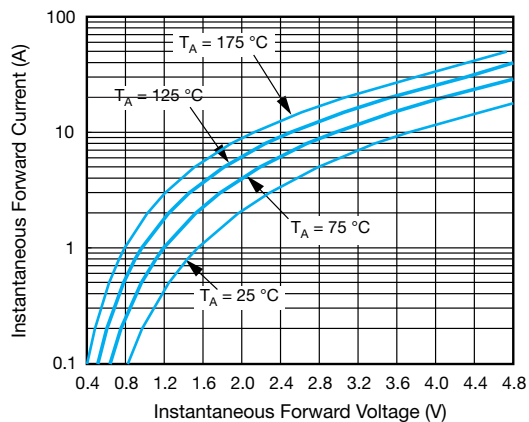


Fig. 3 - Typical Instantaneous Forward Characteristics

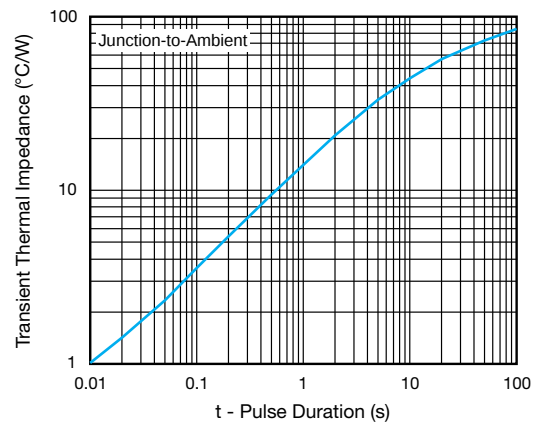
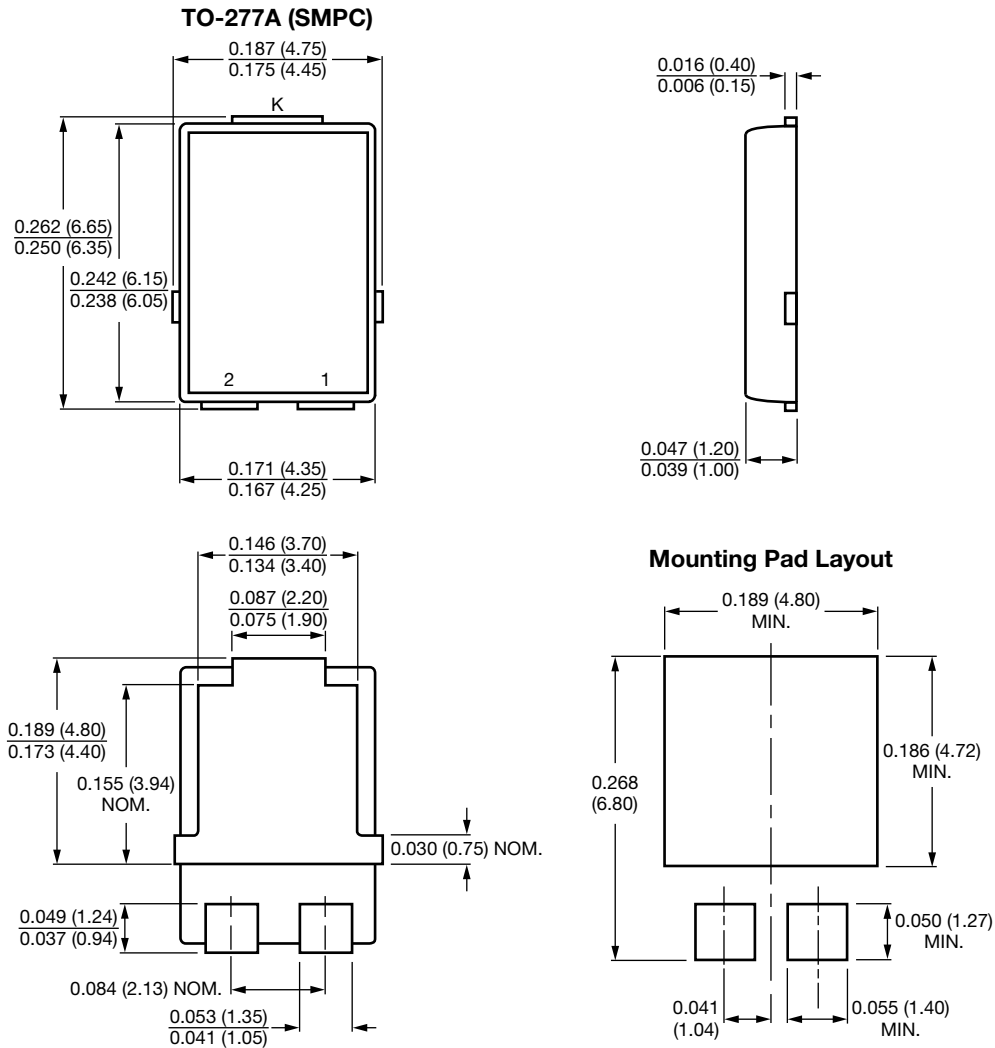


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



Conform to JEDEC® TO-277A

